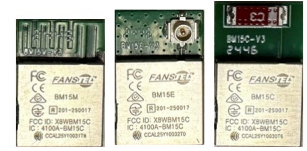


BM05M Series are powerful, highly flexible, ultra low power, and low cost Bluetooth Low Energy (BLE) modules using Nordic nRF54L05 SoC. With an ARM Cortex™ M33 MCU at 128 MHz, 500 KB flash and 96KB RAM, embedded 2.4GHz multi-protocol transceiver, and an integrated PCB trace antenna or a connection for an external antenna. It allows faster time to market with reduced development cost.

BM05M are designed to minimize PCB cost and to maximize efficiency in production line dedicated for Bluetooth modules. The cost of using BM05M modules can be lower than designing-in SoC at any quantity.



BM05M Specifications

BLE 6.0, IEEE 802.15.4-2006 Transceiver

- Complete RF solution with integrated antenna
 - BLE: 2Mbps, 1Mbps (-98 dBm sensitivity), 500kbps, 125kbps (-106 dBm sensitivity).
 - IEEE 802.15.4-2006: 250 kbps (-102 dBm sensitivity).
 - Proprietary: 4Mbps, 2Mbps, 1Mbps.
- Programmable TX power, -8 dBm +8 dBm.
- AoA and AoD direction finding using BLE.
- 128 bit AES/ECB/CCM/AAR co-processor (on-the-fly operation).
- 12.0 mW TX current at 0 dBm, 1Mbps, 1.8V VDD.
- 7.5 mW RX current, 1Mbps, 1.8V VDD.
- RSSI, 1 dB resolution

Platform Security

- Secure/non-secure memory protection.
- Symmetric and asymmetric key crypto accelerator.
- Secure key management.
- Tamper detection.
- Immutable boot partition.
- Debug access port protection.
- Two watchdog timers for secure and non-secure context.

MCU

- Nordic nRF54L with ARM Cortex M33, 128 MHz.
- Flash/RAM: 500KB/96KB.
- 505 EEMAC CoreMark score running from non-volatile memory, 3.95 CoreMark per MHz.
- Single precision floating point unit (FPU).
- Memory protection unit (MPU).
- Digital signal processing (DSP) instructions.
- Serial Wire Debug (SWD)

- Data watchpoint and trace (DWT), embedded trace macrocell (ETM), instrumentation trace macrocell (ITM), and cross trigger interface (CTI).
- Trace port interface unit (TPIU), 4-bit parallel trace of ITM and ETM trace data; Serial wire output (SWO) trace of ITM data.

Peripherals

- Two realtime counters (RTC), and one global RTC (GRTC) that can run in System OFF mode and implement a shared system timer.
- Seven 32-bit timers with counter mode.
- Five fully featured serial interfaces with EasyDMA, supporting I²C, SPI controller/peripheral, and UART.
- Three pulse width modulator (PWM) units with Easy DMA.
- I2S two channel inter-IC sound interface.
- 14-bit at 20KS/s, 12 bit at 250KS/s, or 10-bit at 2MS/s ADC with up to eight programmable gain channels.
- Two quadrature decoders (QDEC).
- 38 LGA pins, 31 GPIOs.
- Embedded inductors for DCDC converter
- 1.7V to 3.6V supply.
- An external 32.768 KHz crystal is not required.
- Operation temperature: -40 °C to +105 °C

Certifications

- FCC ID:
- IS E D ID:
- CE, RCM:
- TELEC ID:
- Taiwan NCC ID: See below
- Q DID:

Model Summaries

module	BM05M	BM05F
SoC	nRF54L05, 500 KB flash; 96 KB RAM	
Size	10.0x14.0mm	10.0x. mm
Antenna	M-PCB Trace	High performance F-PCB
Peak TX, conducted	8.35dBm	8.35dBm
Peak TX, radiated		

Bluetooth 6.0, 802.15.4 Module BM05M

Draft Ver. 90 May 2025

BLE range,1Mbps		
Certifications	BLE	BLE
Taiwan NCC ID		
Availability		

Table Of Contents

1. Introduction	4
BM05M Block Diagram	4
2. BM05M Specifications	6
Nordic SoCs	6
Mechanical Drawings	8
BM15M Pin Map	10
Pin Function Table	11
Mounting BM05M on the Host PCB	13
Suggestion for Battery Power Application	13
3. Bluetooth Range Measurements	14
Measurement Results	14
4. Evaluation Board	15
Loading Firmware into Evaluation Board Through a Nordic DK	15
Evaluation Board Schematics	16
5. Firmware Development	17
Procedures to Load Firmware	17
Setting Up Firmware Development Environment	17
Using Internal Load Capacitors for the High Frequency Oscillator	19
Preloaded Firmware	19
6. Miscellaneous	20
Soldering Temperature-Time Profile for Re-Flow Soldering	20
Cautions, Design Notes, and Installation Notes	20
Packaging	23
FCC Label	23
7. Revision History	24
8. Contact Us	25

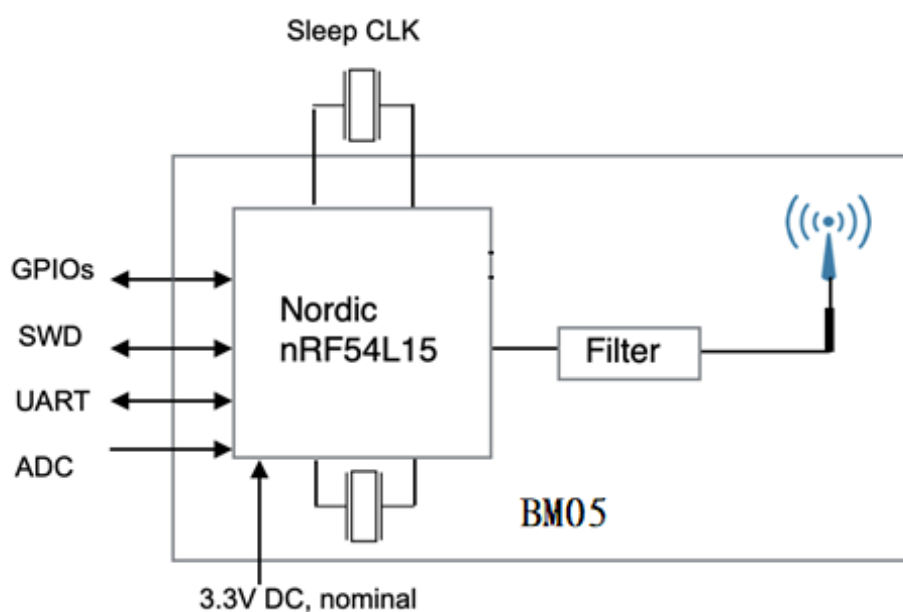
1. Introduction

BM05M module is powerful, highly flexible, ultra low power Bluetooth Low Energy (BLE) modules using Nordic nRF54L05 SoCs. With an ARM Cortex™ M33 MCU at 128 MHz, up to 500 KB flash, 96KB RAM, embedded 2.4GHz multi-protocol transceiver, and an integrated antenna, it allows faster time to market with reduced development cost.

The following is a block diagram of BM05M. Antenna circuit and main clock are integrated. All 31 GPIOs of nRF54L05 can be accessed from main board. For lower power consumption at idle state, a 32.768 kHz crystal is added on the host board. Connection to an external (Near Field Communication) antenna is provided.

In this data sheets, BM05F and, BM05M are referred as BM05M.

BM05M Block Diagram



Summaries of BM05M Series modules.

BM05M

- BM05M: uses an nRF54L05 SoC.
- Cortex M33 MCU at 128 MHz, 500 KB flash, 256 KB RAM
- An integrated PCB trace antenna
- Size: 10.0x14.0mm



BM05F

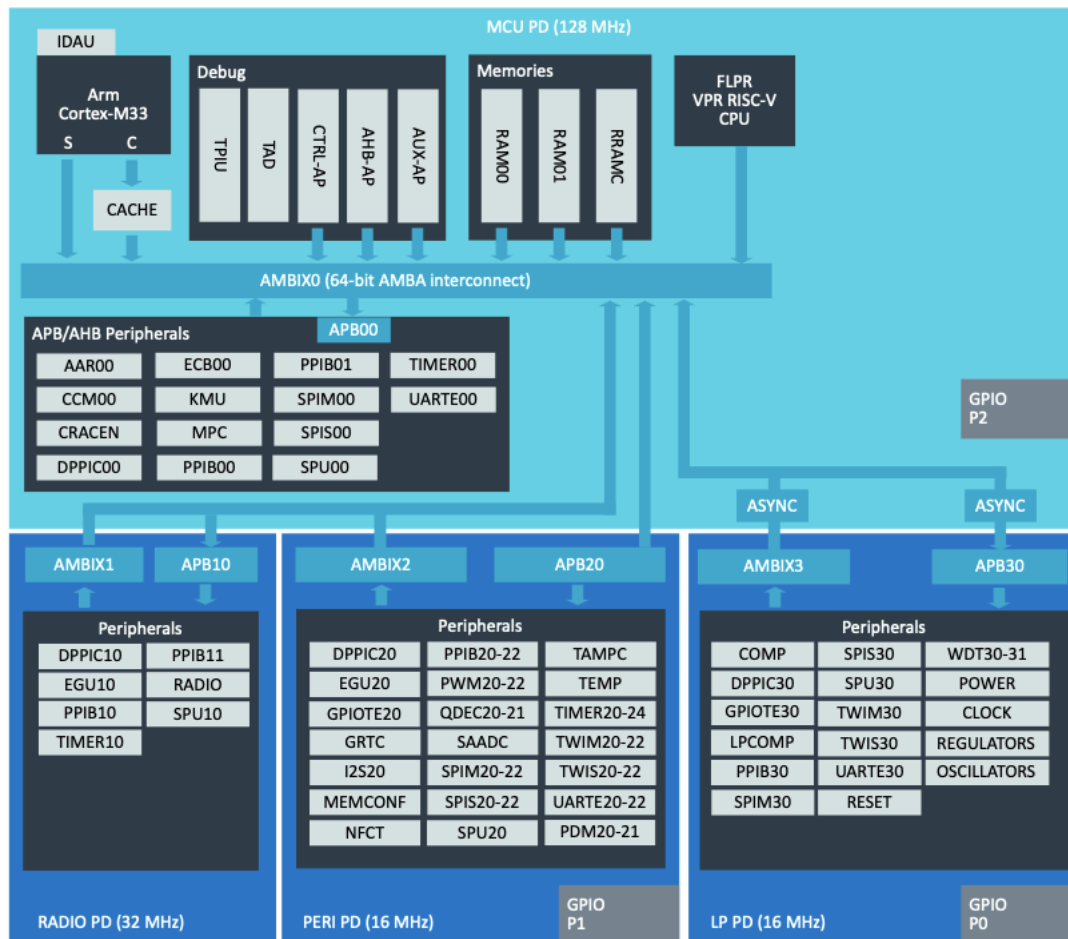
- BM05F: uses an nRF54L05 SoC.
- Cortex M33 MCU at 128 MHz, 500 KB flash, 96 KB RAM
- An integrated high performance PCB antenna.

- Size: 10.0x mm.

2. BM05M Specifications

Nordic SoCs

A block diagram of nRF54L05 is below. This is an ultra-low power SoC with advanced security features, a range of peripherals, and a multiple protocol 2.4 GHz transceiver. It supports Bluetooth Low Energy (BLE), IEEE 802.15.4 for BLE and Zigbee



protocols, and allows for the implementation of proprietary 2.4 GHz protocols.

The main processing unit is an ARM Cortex M33 processor running at up to 128 MHz, supported by nonvolatile RRAM and RAM memory. The ARM Cortex M33 has a full set of digital processing (DSP) instructions and a memory protection unit (MPU) for application security. The full-featured single-precision floating-point unit (FPU) supports all single-precision instructions.

The peripheral set offers a variety of analog and digital functionality enabling single chip implementation of a wide range of applications. Hardware isolation between the secure and non-secure resources, as defined by ARM TrustZone, is implemented in the device. The hardware peripherals can be configured as secure or non-secure.

A key management unit (KMU) provides key storage, that when combined with a cryptographic accelerator (CRACEN), ensures discretion of encryption keys even within the secure world. The cryptographic accelerator has protection against differential power analysis (DPA) attacks.

The device has measures to protect against physical security attacks. It can detect and report fault injection attacks such as voltage glitching or electromagnetic fault injection. An external active shield I/O interface provides PCB or product level security for the detection of a product's encapsulation being opened, or product tampering.

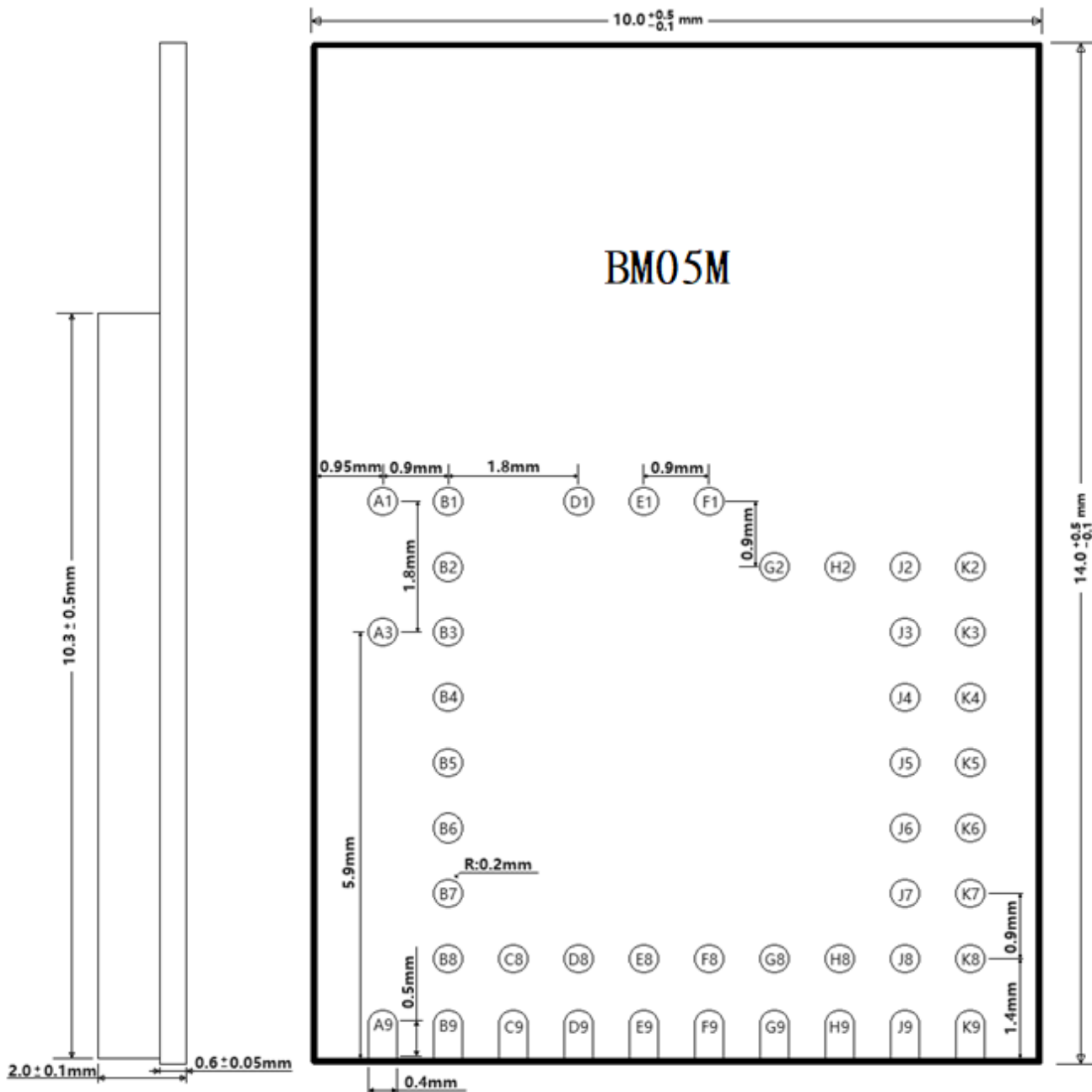
The device non-volatile memory has a boot region that can be made immutable before the CPU starts up. Boot initiated from an immutable source allows subsequent boot steps to be performed by authenticated code.

The debug access port can be enabled or disabled to allow either non-intrusive or intrusive debugging, from secure or non secure worlds. The non volatile memory can be protected against erasing, providing protection from unauthenticated repurposing. Authenticated debug access control, such as facilitating the ARM ADAC architecture, is supported through a hardware mailbox. The mailbox allows on-chip firmware to authenticate the debug host before enabling the device debug interface.

The device has a dedicated RISC-V CPU (VPR), which is a fast, lightweight peripheral processor (FLPR) dedicated for software defined peripherals.

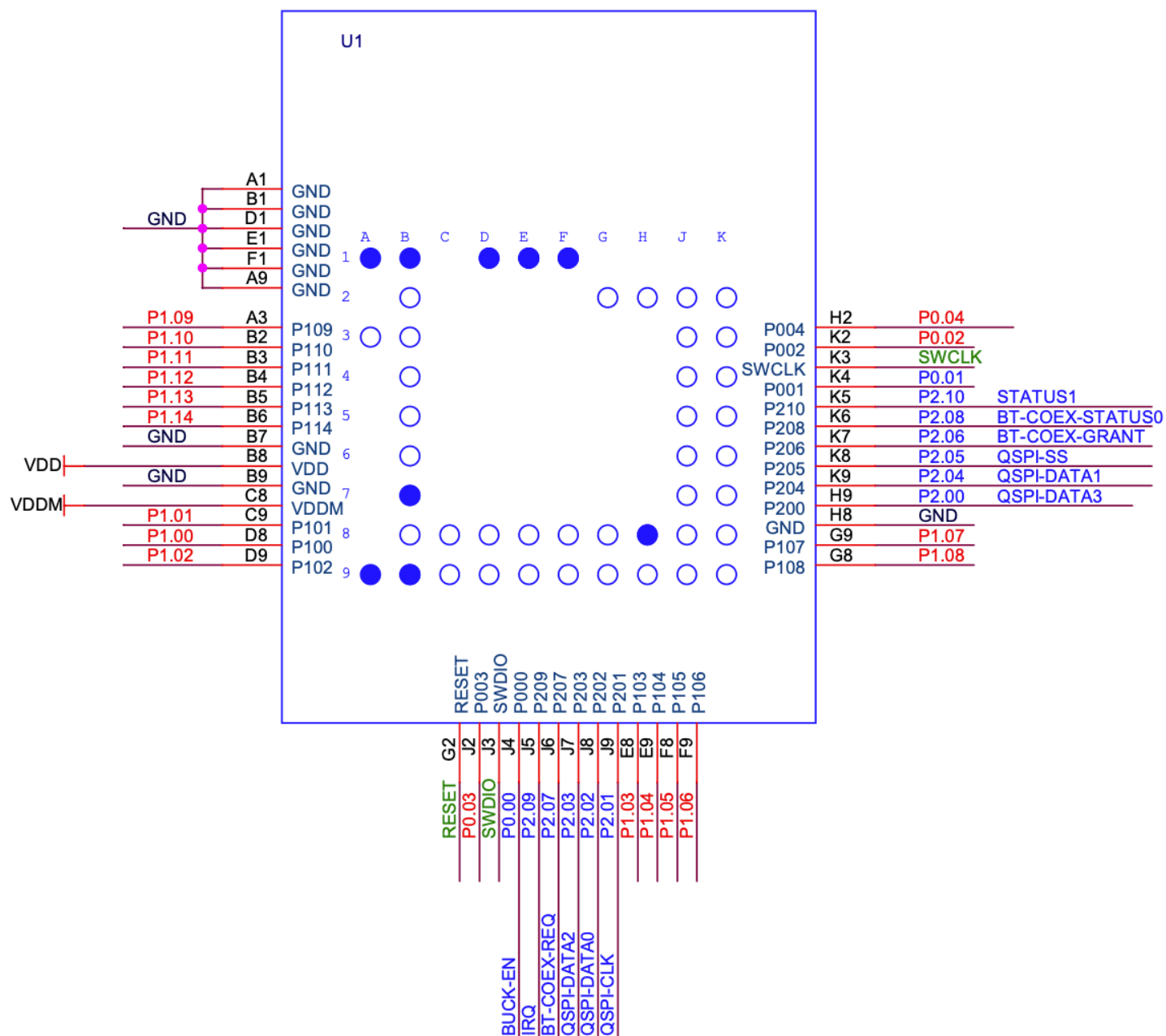
Mechanical Drawings

The following is mechanical drawings of BM05M, top view.



BM05M Pin Map

The following is a pin map of BM05M Series modules.



Pin Function Table

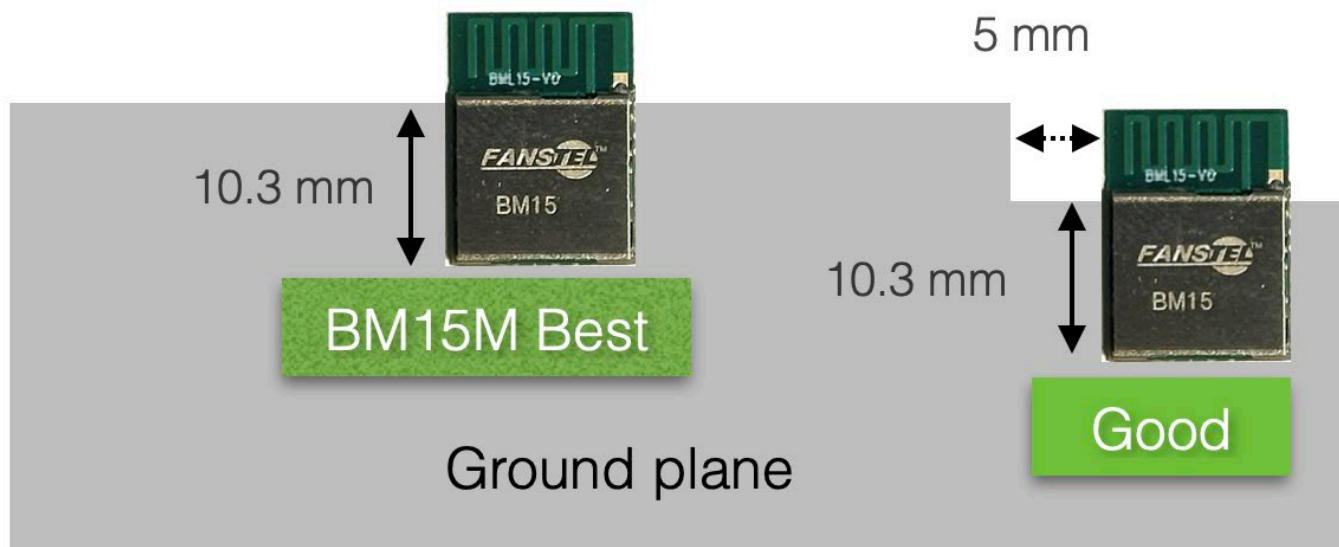
In this section, the following abbreviations are used.

- BM05, an nRF54L05 Bluetooth module representing BM05M and BM05F.
- L05, nRF54L05.

BM05 pin#	L05 pin#	Name	Descriptions
A1		GND	Ground
A3	37	P109	GPIO
A9		GND	Ground
B1		GND	Ground
B2	38	P110	GPIO
B3	39	P111	GPIO, Analog input AIN4;
B4	40	P112	GPIO, Analog input AIN5;
B5	41	P113	GPIO, Analog input AIN6;
B6	42	P114	GPIO, Analog input AIN7;
B7	49	GND	Ground
B8	36	VDD	1.7V to 3.6V;
B9	49	GND	Ground
C8	48	VDD	Main power supply, 3V nominal, 1.7V to 3.6V.
C9	2	P101	GPIO, connection for 32.768 kHz crystal
D1		GND	Ground
D8	1	P100	GPIO, connection for 32.768 kHz crystal
D9	3	P102	GPIO, pin.
E1		GND	Ground
E8	4	P103	GPIO
E9	5	P104	GPIO, Analog input AIN0;
F1		GND	Ground
F8	6	P105	GPIO, Analog input AIN1;
F9	7	P106	GPIO, Analog input AIN2;
G2	30	/Reset	/Reset, active low.
G8	9	P108	GPIO
G9	8	P107	GPIO, Analog input AIN3
H2	29	P004	GPIO
H8	49	GND	Ground
H9	11	P200	GPIO
J2	28	P003	GPIO
J3	25	SWDIO	Serial Wire Debug data.
J4	23	P000	GPIO;
J5	20	P209	GPIO;
J6	18	P207	GPIO;

J7	14	P203	GPIO;
J8	13	P202	GPIO;
J9	12	P201	GPIO;
K2	27	P002	GPIO
K3	26	SWDCLK	Serial Wire Debug clock
K4	24	P001	GPIO;
K5	21	P210	GPIO;
K6	19	P208	GPIO;
K7	17	P206	GPIO;
K8	16	P205	GPIO;
K9	15	P204	GPIO;

Mounting BM05M on the Host PCB



BM05F or BM05M with an integrated antenna is referred as BM05M in this section. It shall follow these mounting guidelines.

The length of the RFI shield is 10.3 mm. The RFI shield area is the main body of module. The rest of the module is called antenna area.

- The main body area can be on a host board ground plane. The antenna area must be extended outside of the host board or in an area without ground or signal trace.
- The length of BM05M antenna area is 5.5 mm.
- The length of BM15M antenna area is 3.7mm.
- We don't recommend mounting BM15M module in the middle of a host PCB.

For the best Bluetooth range performance, keep all external metal at least 30mm from the antenna area.

Suggestion for Battery Power Application

Standby current consumption is important for battery-powered product. We suggest adding a 32.768 kHz crystal as shown in the evaluation board schematics. The 32MHz main clock won't be active at idle state to save power.

Two inductors required for DCDC converter are inside BM15 module. You can enable DCDC to lower power consumption.

3. Bluetooth Range Measurements

Bluetooth range measurement hex codes can be downloaded from **Bluetooth Range Measurements** section of this webpage.

To be provided.

Description of measurement site, measurement methods, and range raw data are available at:

<https://www.fanstel.com/testreport/>

Measurement Results

To be provided.

4. Evaluation Board

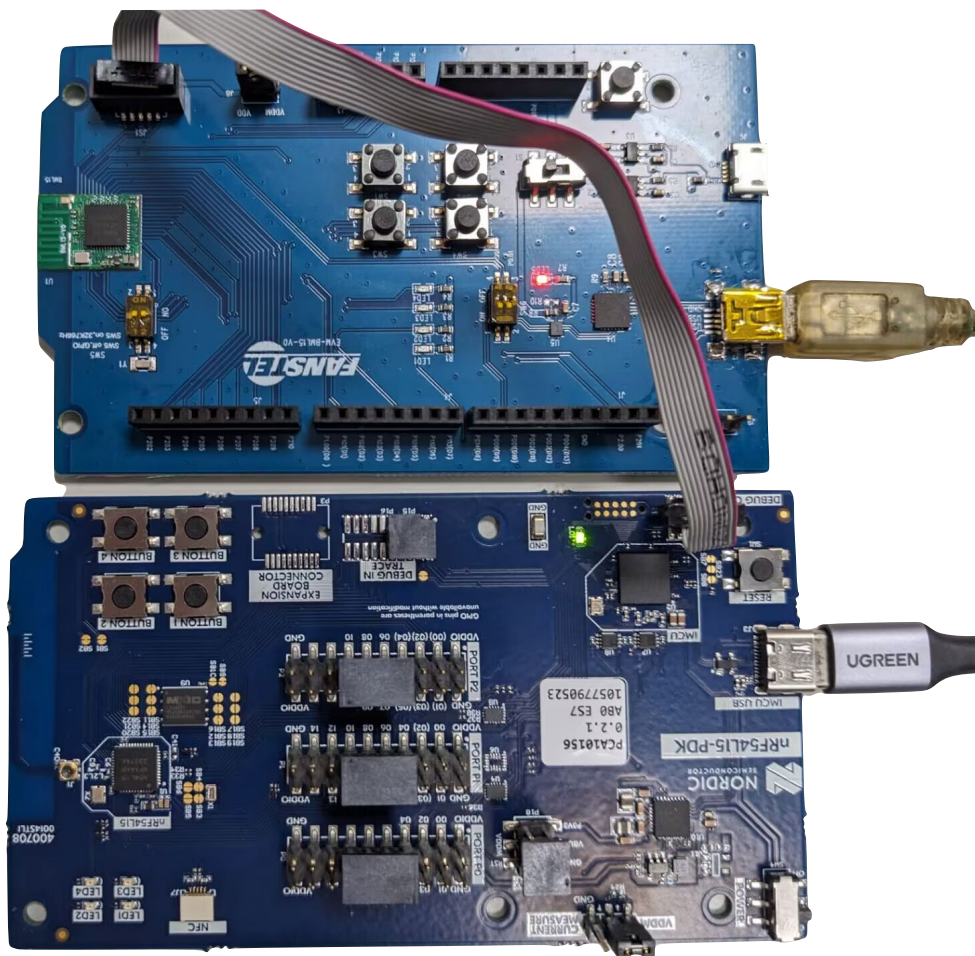
An evaluation board can be used to evaluate performance of module and to develop and test your firmware before an application-specific host board is developed.

Loading Firmware into Evaluation Board Through a Nordic DK

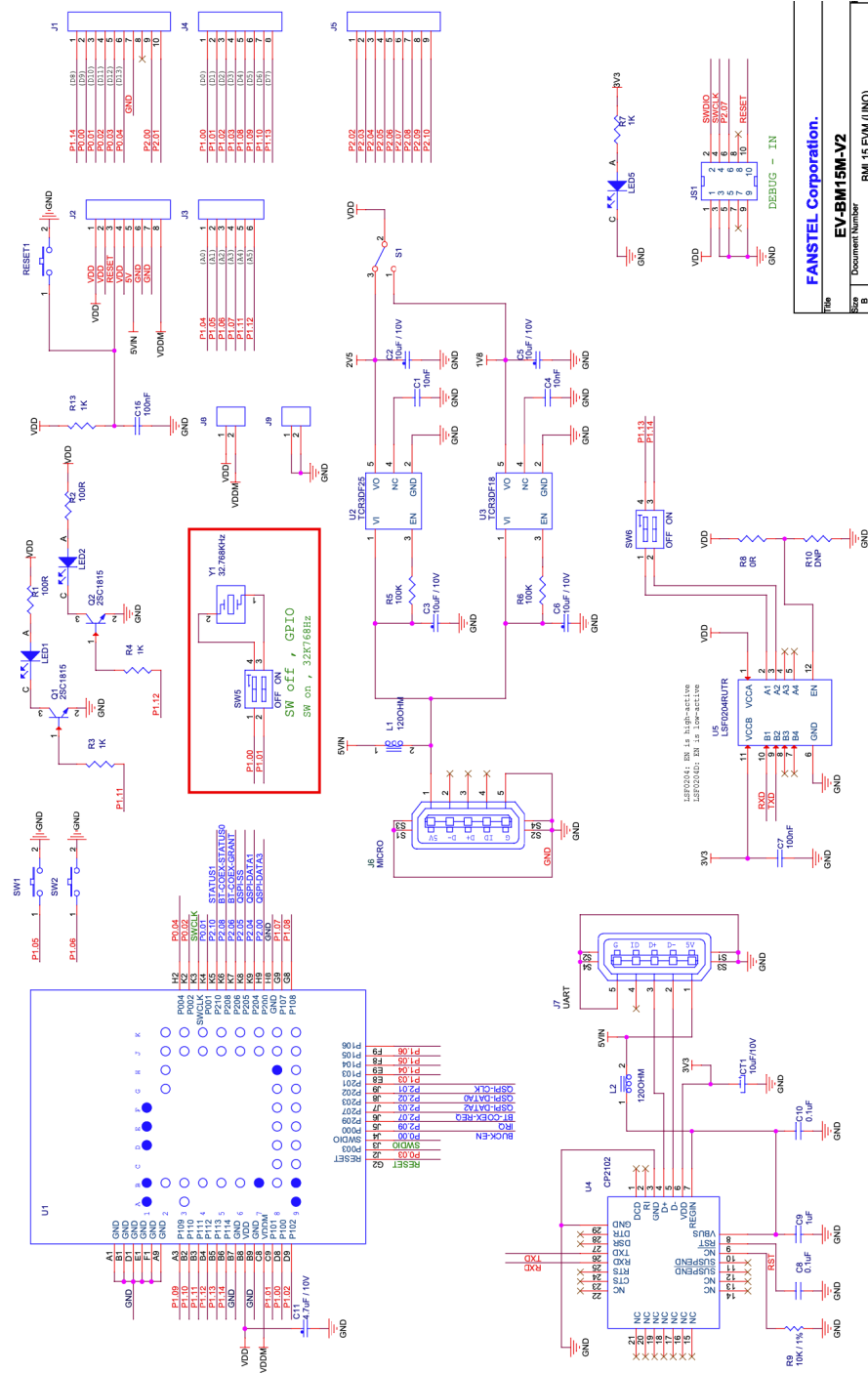
A Nordic nRF54L05 PDK or DK is required to load firmware into EV-BM05M.

Procedures to connect a Nordic DK to a Fanstel nRF54 module evaluation board.

- Connect Nordic nRF54L05 DK debug out to Fanstel evaluation board debug in using the 10-pin flat cable as shown below.
- Connect Nordic nRF4L15 DK to PC.
- Connect a DC power source to micro or mini USB port of evaluation board.



Evaluation Board Schematics



5. Firmware Development

Procedures to Load Firmware

[EV-BM15 hex codes and source codes](#) can be downloaded from the Fanstel website.

Open command line tool and execute the programming commands.

```
nrfjprog -f NRF54L --recover
```

```
nrfjprog -f NRF54L --program BML15_231129.hex --chiperase --verify --reset
```

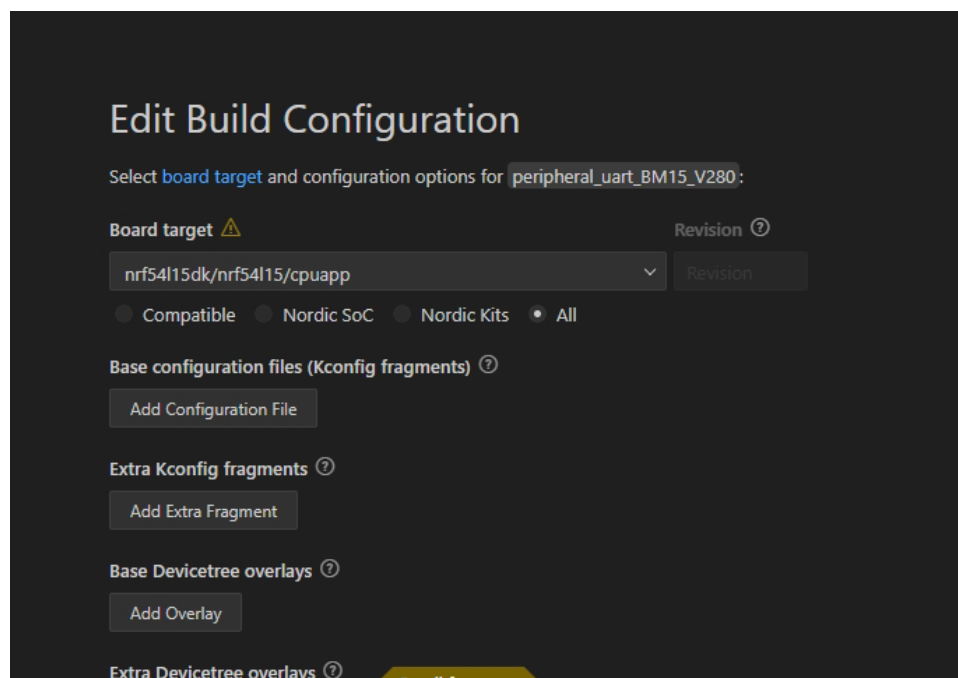
```
C:\Users\Leo\Desktop\Nordic_Firmware\BML15_231129\HEX>nrfjprog -f NRF54L --recover
Recovering device. This operation might take 30s.
Erasing user code and UICR flash areas.

C:\Users\Leo\Desktop\Nordic_Firmware\BML15_231129\HEX>nrfjprog -f NRF54L --program BML15_231129.hex --chiperase --verify
--reset
[ ##### ] 0.261s | Erase file - Done erasing
[ ##### ] 3.951s | Program file - Done programming
[ ##### ] 1.720s | Verify file - Done verifying
Applying system reset.
Run.

C:\Users\Leo\Desktop\Nordic_Firmware\BML15_231129\HEX>
```

Setting Up Firmware Development Environment

Please use nRF Connect SDK version 2.8.0 or newer for development. The previous versions of nRF Connect SDK do not support the BM05M. Please select the board nRF54L05dk/nRF54L05/cupapp. nRF54L05 silicon.



Create an overlay file to configure the hardware peripherals to match your specific hardware. The following is an example setup for the nRF54L05dk/nRF54L05.overlay file.

```

20 //-----
21 //OSC32KRC.INTCAP 0x50120904
22 //"/nordic,nrf-1fxo".yaml([4000:18000] ,step 500)
23 &1fxo {
24     load-capacitors = "internal";
25     load-capacitance-femtofarad = <15500>;
26 };
27
28 &pinctrl {
29     /omit-if-no-ref/ uart20_default: uart20_default {
30         group1 {
31             psels = <NRF_PSEL(UART_TX, 1, 13)>;
32         };
33         group2 {
34             psels = <NRF_PSEL(UART_RX, 1, 14)>;
35             bias-pull-up;
36         };
37     };
38
39     /omit-if-no-ref/ uart20_sleep: uart20_sleep {
40         group1 {
41             psels = <NRF_PSEL(UART_TX, 1, 13)>,
42                 <NRF_PSEL(UART_RX, 1, 14)>;
43             low-power-enable;
44         };
45     };
46 };
47
48 &uart20 {
49     status = "okay";
50     current-speed = <115200>;
51     pinctrl-0 = <&uart20_default>;
52     pinctrl-1 = <&uart20_sleep>;
53     pinctrl-names = "default", "sleep";

```

After completing the setup, build and flash the code. Ensure that the code is running properly.

```

Restore: CONFIG_MBEDTLS_PSA_CRYPTO_C: True
Restore: CONFIG_MBEDTLS_PSA_CRYPTO_KEY_ID_ENCODES_OWNER: False
Restore: CONFIG_MBEDTLS_PSA_CRYPTO_SPM: False
Restore: CONFIG_MBEDTLS_USE_PSA_CRYPTO: True
Restore: CONFIG_MBEDTLS_PLATFORM_PRINTF_ALT: False
Restore: CONFIG_MBEDTLS_THREADING: False
Restore: CONFIG_MBEDTLS_THREADING_ALT: True
===== End psa_crypto_library_config =====
CMake Warning at C:/nRF91_241105_V280/v2.8.0/zephyr/CMakeLists.txt:2134 (message):
  __ASSERT() statements are globally ENABLED

-- Configuring done
-- Generating done
-- Build files have been written to: C:/MyNordicTestV280/peripheral_uart_BM15_V280/build/peripheral_uart_BM15_V280
-- Configuring done
-- Generating done
-- Build files have been written to: C:/MyNordicTestV280/peripheral_uart_BM15_V280/build
[68/68] Linking C executable zephyr\zephyr.elf
Memory region      Used Size  Region Size  %age Used
FLASH:             240056 B    1420 KB     16.51%
RAM:                37044 B     188 KB     19.24%
IDT_LIST:           0 GB       32 KB       0.00%
Generating files from C:/MyNordicTestV280/peripheral_uart_BM15_V280/build/peripheral_uart_BM15_V280/zephyr/zephyr.elf for
[5/5] Generating ../merged.hex
[*] Terminal will be reused by tasks, press any key to close it.

```

Use RTT Viewer or UART to monitor the logs and confirm that the code is functioning as expected.

```
00> 40 c2 f3 32 |@..2
00> [00:00:00.021,489] <inf> bt_hci_core: HW Platform: Nordic Semiconductor (0x0002)
00> [00:00:00.021,506] <inf> bt_hci_core: HW Variant: nRF54Lx (0x0005)
00> [00:00:00.021,520] <inf> bt_hci_core: Firmware: Standard Bluetooth controller (0x00) Version 254.63788 Build 573996906
00> [00:00:00.021,954] <inf> bt_hci_core: No ID address. App must call settings_load()
00> [00:00:00.021,962] <inf> peripheral_uart: Bluetooth initialized
00> [00:00:00.022,481] <inf> bt_hci_core: Identifi0m
00> [0m
```

Using Internal Load Capacitors for the High Frequency Oscillator

The external load capacitors for the 32MHz crystal are not mounted. An Epson or equivalent +/-10 PPM crystal is connected to XC1 and XC2 pins. The Bluetooth signal frequencies are within specifications if the internal load capacitors are not enabled. Use the following procedures to set the internal load capacitors to:

The internal load capacitors can be programmed from 4.0 pF to 17pF in 0.5 pF steps. The addresses and description of registers for programming the value of load capacitors are from the nRF54L05 product specifications.

To set up the internal capacitance, please configure it in the overlay file.

XOSC32M.CONFIG.INTCAP step 0.25 pf

```
&hfxo {
    load-capacitors = "internal";
    load-capacitance-femtofarad = <17000>;
};
```

XOSC32KL.INTCAP step 0.5 pf

```
&lfxo {
    load-capacitors = "internal";
    load-capacitance-femtofarad = <7000>;
};
```

Read the memory back to confirm.

```
nrfjprog --memrd 0x5012071C
```

The internal load capacitance shall be set to 17 pF for BM05M, BM15E, and BM15M modules.

Preloaded Firmware

The module is preloaded with firmware designed for factory testing purposes. The firmware is based on the Nordic NUS example. The preloaded source codes can be downloaded from the following link:

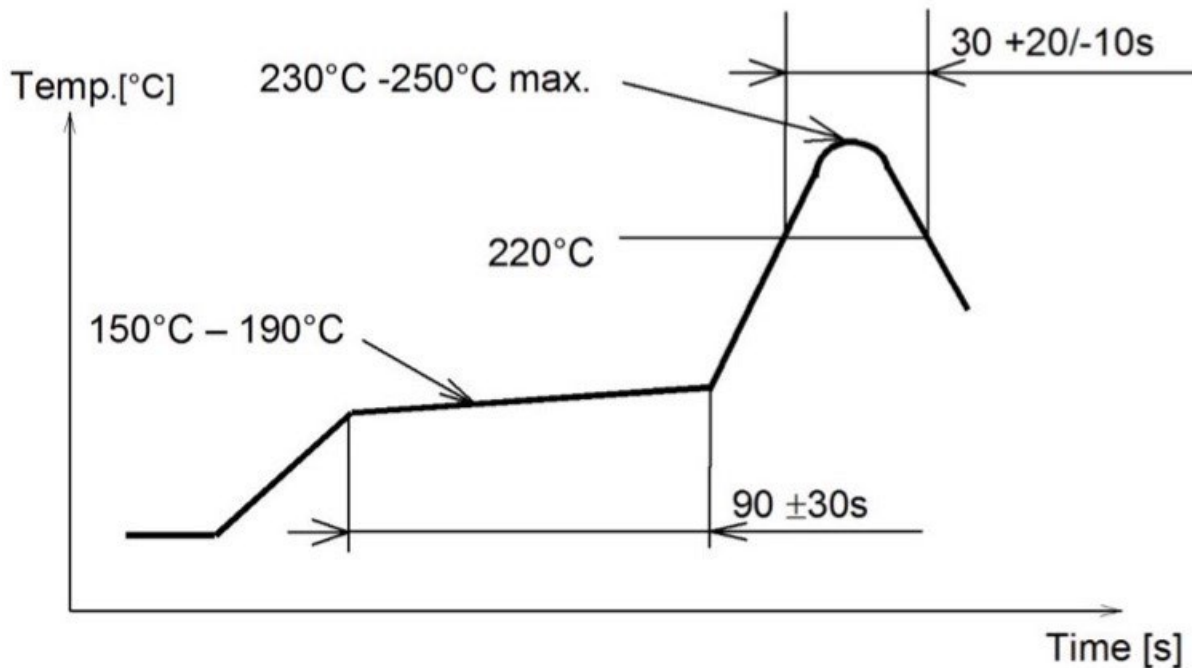
https://www.dropbox.com/scl/fi/o9jebdh7hfmvn1c wd769m/32M_CL-8pF-32K_CL-9pF-BlueNor_v280_BM15M_241119.7z?rlkey=ox0p6udd3mzsdz1djvs1u09g&st=umimp4wm&dl=0

We suggest erasing the preloaded firmware before loading your own codes.

6. Miscellaneous

Soldering Temperature-Time Profile for Re-Flow Soldering

Maximum number of cycles for re-flow is 2. No opposite side re-flow is allowed.



Cautions, Design Notes, and Installation Notes

Failure to follow the guidelines set forth in this document may result in degrading of the product s functions and damage to the product.

Design Notes

- (1) Follow the conditions written in this specification, especially the control signals of this module.
- (2) The supply voltage has to be free of AC ripple voltage (for example from a battery or a low noise regulator output). For noisy supply voltages, provide a decoupling circuit (for example a ferrite in series connection and a bypass capacitor to ground of at least 47uF directly at the module).
- (3) This product should not be mechanically stressed when installed.
- (4) Keep this product away from heat. Heat is the major cause of decreasing the life of these products.
- (5) Avoid assembly and use of the target equipment in conditions where the products' temperature may exceed the maximum tolerance.
- (6) The supply voltage should not be exceedingly high or reversed. It should not carry noise and/or spikes.

(7) this product away from other high frequency circuits.

Notes on Antenna and PCB Layout

(1) Don't use a module with internal antenna inside a metal case.

(2) For PCB layout:

- Avoid running any signal line below module whenever possible,
- No ground plane below antenna,
- If possible, cut-off the portion of main board PCB below antenna.

Installation Notes

(1) Reflow soldering is possible twice based on the time-temperature profile in this data sheets. Set up the temperature at the soldering portion of this product according to this reflow profile.

(2) Carefully position the products so that their heat will not burn into printed circuit boards or affect the other components that are susceptible to heat.

(3) Carefully locate these products so that their temperatures will not increase due to the effects of heat generated by neighboring components.

(4) If a vinyl-covered wire comes into contact with the products, then the cover will melt and generate toxic gas, damaging the insulation. Never allow contact between the cover and these products to occur.

(5) This product should not be mechanically stressed or vibrated when reflowed.

(6) If you want to repair your board by hand soldering, please keep the conditions of this chapter.

(7) Do not wash this product.

(8) Refer to the recommended pattern when designing a board.

(9) Pressing on parts of the metal cover or fastening objects to the metal will cause damage to the unit.

(10) For more details on LGA (Land Grid Array) soldering processes refer to the application note.

Usage Condition Notes

(1) Take measures to protect the unit against static electricity. If pulses or other transient loads (a large load applied in a short time) are applied to the products, check and evaluate their operation before assembly on the final products.

(2) Do not use dropped products.

(3) Do not touch, damage or soil the pins.

(4) Follow the recommended condition ratings about the power supply applied to this product.

(5) Electrode peeling strength: Do not add pressure of more than 4.9N when soldered on PCB

(6) Pressing on parts of the metal cover or fastening objects to the metal cover will cause damage.

(7) These products are intended for general purpose and standard use in general electronic equipment, such as home appliances, office equipment, information and communication equipment.

Storage Notes

- (1) The module should not be stressed mechanically during storage.
- (2) Do not store these products in the following conditions or the performance characteristics of the product, such as RF performance will be adversely affected:
 - Storage in salty air or in an environment with a high concentration of corrosive gas.
 - Storage in direct sunlight
 - Storage in an environment where the temperature may be outside the range specified.
 - Storage of the products for more than one year after the date of delivery storage period.
- (3) Keep this product away from water, poisonous gas and corrosive gas.
- (4) This product should not be stressed or shocked when transported.
- (5) Follow the specification when stacking packed crates (max. 10).

Safety Conditions

These specifications are intended to preserve the quality assurance of products and individual components. Before use, check and evaluate the operation when mounted on your products. Abide by these specifications, without deviation when using the products. These products may short-circuit. If electrical shocks, smoke, fire, and/or accidents involving human life are anticipated when a short circuit occurs, then provide the following failsafe functions, as a minimum.

- (1) Ensure the safety of the whole system by installing a protection circuit and a protection device.
- (2) Ensure the safety of the whole system by installing a redundant circuit or another system to prevent a dual fault causing an unsafe status.

Other Cautions

- (1) This specification sheet is copyrighted. Reproduction of this data sheet is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices.
- (2) Do not use the products for other purposes than those listed.
- (3) Be sure to provide an appropriate failsafe function on your product to prevent an additional damage that may be caused by the abnormal function or the failure of the product.
- (4) This product has been manufactured without any ozone chemical controlled under the Montreal Protocol.
- (5) These products are not intended for other uses, other than under the special conditions shown below. Before using these products under such special conditions, check their performance and reliability under the said special conditions carefully to determine whether or not they can be used in such a manner.
 - In liquid, such as water, salt water, oil, alkali, or organic solvent, or in places where liquid may splash.
 - In direct sunlight, outdoors, or in a dusty environment
 - In an environment where condensation occurs.

- In an environment with a high concentration of harmful gas.
- (6) If an abnormal voltage is applied due to a problem occurring in other components or circuits, replace these products with new products because they may not be able to provide normal performance even if their electronic characteristics and appearances appear satisfactory.
- (7) When you have any question or uncertainty, contact Fanstel.

Packaging

Production modules are delivered in reel, 1000 modules in each reel.

FCC LABEL

The Original Equipment Manufacturer (OEM) must ensure that the OEM modular transmitter must be labeled with its own FCC ID number. This includes a clearly visible label on the outside of the final product enclosure that displays the contents shown below. If the FCC ID is not visible when the equipment is installed inside another device, then the outside of the device into which the equipment is installed must also display a label referring to the enclosed equipment

The end product with this module may subject to perform FCC part 15 unintentional emission test requirement and be properly authorized.

This device is intended for OEM integrator only.

7. Revision History

- May 2025, Ver. 0.90: The first draft copy

8. Contact Us

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Federal Communications Commission (FCC) Statement

15.21

You are cautioned that changes or modifications not expressly approved by the part responsible for compliance could void the user's authority to operate the equipment.

15.105(b)

This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications.

However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- 1) this device may not cause harmful interference, and
- 2) this device must accept any interference received, including interference that may cause undesired operation of the device.

FCC RF Radiation Exposure Statement

The antenna(s) used for this transmitter must be installed to provide a separation distance of at least 20 cm from all persons and must not be co-located or operating in conjunction with any other transmitter, except in accordance with FCC multi-transmitter product procedures.

This equipment should be installed.

Note: The end product shall have the words "Contains Transmitter Module **FCC ID: X8WBM05**"

Canada, Industry Canada (IC)

This Class B digital apparatus complies with Canadian ICES-003

Cet appareil numérique de classe B est conforme à la norme NMB-003.

This device complies with Industry Canada licence-exempt RSS standard(s). Operation is subject to the following two conditions: (1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the
Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes:

(1) l'appareil ne doit pas produire de brouillage, et

(2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

Conformité des appareils de radiocommunication aux limites d'exposition humaine aux radiofréquences (CNR-102)

L'ordinateur utilise des antennes intégrales à faible gain qui n'émettent pas un champ électromagnétique supérieur aux normes imposées par Santé Canada pour la population. Consultez le Code de sécurité 6 sur le site Internet de Santé Canada à l'adresse suivante : <http://www.hc-sc.gc.ca/>

L'énergie émise par les antennes reliées aux cartes sans fil respecte la limite d'exposition aux radiofréquences telle que définie par Industrie Canada dans la clause 4.1 du document CNR-102, version 4.

Caution: Exposure to Radio Frequency Radiation.

L'antenne ou les antennes utilisées pour cet émetteur doivent être installées de manière à assurer une distance de séparation d'au moins 20 cm par rapport à toutes les personnes et ne doivent pas être situées à proximité ou fonctionner en conjonction avec un autre émetteur, sauf conformément aux procédures de la FCC relatives aux produits multi-émetteurs. Cet équipement doit être installé.

(Modular approval) End Product Labeling:

The final end product must be labeled in a visible area with the following: “Contains IC: 4100A-BM05

Le produit final doit être étiqueté dans une zone visible avec ce qui suit “Contient IC : 4100A-BM05

OEM statement

The Original Equipment Manufacturer (OEM) must ensure that the OEM modular transmitter must be labeled with its own FCC ID number. This includes a clearly visible label on the outside of the final product enclosure that displays the contents shown below. If

the FCC ID is not visible when the equipment is installed inside another device, then the outside of the device into which the equipment is installed must also display a label referring to the enclosed equipment.

The end product with this module may subject to perform FCC part 15B unintentional emission test requirement and be properly authorized while installation to host(s), and platform, and integrator are obligated to have its manual or instruction with the related compliance warning to end users.

This device is intended for OEM integrator only

The end product with this module may be subject to re-evaluate RF exposure as per 47CFR §

2.1091, and §2.1093 if antenna or usage, including co-located usage of other transmitters, of the subsequent installation are changed.

This radio transmitter has been approved by FCC/Innovation, Science and Economic Development Canada to operate with the antenna types listed below, with the maximum permissible gain indicated. Antenna types not included in this list that Have a gain greater than the maximum gain indicated for any type listed are strictly prohibited for use with this device.

F-PCB antennas: 4.54 dBi M-PCB antennas: -0.03 dBi

Cet émetteur radio a été approuvé par FCC/Innovation, Science et Développement économique Canada pour fonctionner avec les types d'antennes répertoriés ci-dessous, avec le gain maximal autorisé indiqué. Les types d'antenne non inclus dans cette liste qui ont un gain supérieur au gain maximum indiqué pour tout type répertorié sont strictement interdits pour une utilisation avec cet appareil.

F-PCB antennas: 4.54 dBi M-PCB antennas: -0.03 dBi

NCC 警語:

低功率產品警語：「取得審驗證明之低功率射頻器材，非經核准，公司、商號或使用者均不得擅自變更頻率、加大功率或變更原設計之特性及功能。低功率射頻器材之使用不得影響飛航安全及干擾合法通信；經發現有干擾現象時，應立即停用，並改善至無干擾時方得繼續使用。前述合法通信，指依電信管理法規定作業之無線電通信。低功率射頻器材須忍受合法通信或工業、科學及醫療用電波輻射性電機設備之干擾。」